



# **Product Change Notification**

## **113029 - 00**

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**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

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# Product Change Notification

**Change Notification #:** 113029 - 00  
**Change Title:** Intel® Integrated RAID Module  
RMS25CB040, RMS25CB080, and  
RMT3CB080  
PCN 113029-00, Product Design  
Update Firmware  
**Date of Publication:** May 15, 2014

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material *:</b>	Jun 08, 2014
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*\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

## Description of Change to the Customer:

Intel is implementing the following change on the Intel® Integrated RAID Module RMS25CB040, RMS25CB080, and RMT3CB080:

1. Updated the firmware to version v23.28.0 0010, which can set the RAID module cache policy from Write Back to Write Through when a scheduled learn cycle of the RAID Maintenance Free Backup Unit fails to complete successfully.  
Please refer to the Technical Advisory TA-1052-1 for more information about this firmware. The TA-1052-1 can be found at  
<http://download.intel.com/support/motherboards/server/sb/ta10521.pdf>.

## Customer Impact of Change and Recommended Action:

Intel recommends that the customer perform a standard level of evaluation. Customers can download the latest firmware package from Intel website:

<http://www.intel.com/support>.

**Products Affected / Intel Ordering Codes:**

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
RMS25CB080	924871	G34894-611	G35316-611	G34894-612	G35316-612
RMS25CB040	924872	G34895-611	G41024-611	G34895-612	G41024-612
RMT3CB080	924873	G34899-611	G41025-611	G34899-612	G41025-612

**PCN Revision History:****Date of Revision:**

May 15, 2014

**Revision Number:**

00

**Reason:**

Originally Published PCN